

University of Sheffield ADvanced Additive Manufacturing

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Introduction to the University of Sheffield





Equipment at Sheffield

Polymers: (polyamides, elastomeric)

- Objet polymer jetting
- EOS Laser Sintering
- Custom made High Speed Sintering

Other Advanced Manufacturing Techniques:

- Metal Injection Moulding
- Spark Plasma Sintering
- Electron Beam Welding, with wirefeed capability

Metals:

Arcam Electron Beam Melting A2, S12 Renishaw AM250 + SLM 125, Optomec Aerosol Jet Huffman Contour Precision blown powder ExOne binder jet printer











Areas of research

- Minimum mass structures
- Lattice structures
- Alloy Development





Bloodhound SSC







Minimal mass structures Designed using Structural Topology Optimisation





Original Design

Topology Optimised Design

69% weight saving achieved using through Structural Topology Optimisation





Minimal mass structures Designed using Structural Topology Optimisation

Load Test: Cantilever #2

Test Duration: 00:15:51

Failure Load: 342 kN





Minimal mass structures Issues with dimensional accuracy



Truss members not aligned with the build direction are not fabricated accurately

** They are always undersized **





Characterizing the problem Fabricating arbitrary truss specimens



Truss specimens with members at a range of angles to the build direction (20 - 60°) Several member diameters explored (2, 5 and 10mm)





Comparison of scans



'Default'

'Modified 2'





Lattice Structures:





Different Lattices

- Aim to understand simple elements of repeated lattices
- Potential to design in *"metamaterial"* behaviours

R Lakes, Science 235 (1987) 1038











Dynamic tests

"Distal-face" tests. HDPE striker ≈200m/s, re-entrant





"Impact-face" tests. HDPE striker ≈136m/s, re-entrant cube









Material development



15



Material development approach

Process maps based on heat input and material physical properties





AM Tungsten

Tungsten used in first wall due to :

- Low activation under neutron irradiation
- High melting point
- Good thermal conductivity
- SLM Tungsten Density 94%
- Future work EBM Tungsten via small build tank







SLM Tungsten Porosity





Overview of AM Technologies





Additive Manufacture

Laser sintering Micro-scale 3D printing **Metals Polymers** Hybrid structures Fewer processing steps

Complex shapes

Less waste



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Powder bed systems



- Accurate beam positioning allows fine details
- Surrounding powder supports complex structure
- Restricted by bed size





manufacturing

points in aerostructures in recent years, and,

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Powder bed systems



Build envelope

- Max laser system 800mm
 x 400mm x500mm
- Max EB system dia.
 350mm x 380mm

Deposition rates

• 20 to 80cm³/hr Min feature size

100 to 400µm

Materials readily processed

- Titanium alloys
- Nickel based alloys
- Steels/stainless steels
- INVAR
- Precious metals

Materials possible

- Aluminium alloys
- Copper alloys
- Tungsten
- Bulk metallic glasses
- High entropy alloys
- Ceramics





Blown powder systems



- High deposition rates
- Cladding and repair capability
- Multi materials possible
- Adding features to existing parts







Image courtesy of Contour Precision

Image courtesy of RPM Innovations





Blown powder systems



High Deposition rates 25cm³/hr to 160cm³/hr Layer thickness 0.1 to 1.5mm Positional accuracy +/- 0.25mm Minimum feature size 0.5 to 1mm





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Wire deposition







Very high Deposition rates

- 100cm³/hr to 320cm³/hr
 Build envelope
- Chamber systems up to 1.5m x 1.5m





Wire deposition

- Large component manufacture
- Requires machining to net shape
- Add features to simple shapes

Materials

- Aluminium
- Stainless steel
- Titanium
- Nickel alloys





Image courtesy of NASA.



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Hybrid systems



Combines blown powder with CNC machining



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Functional printing



Inkjet or Aerosol Jet printing allows direct write of electronic circuits

Integration of: Printed structures Channels for wiring Printed electronics







Printoptical

3D printing of optical lenses

- Full transparent
- Perfectly smooth
- Optically functional









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